

[View on rigaku.com](https://www.rigaku.com)

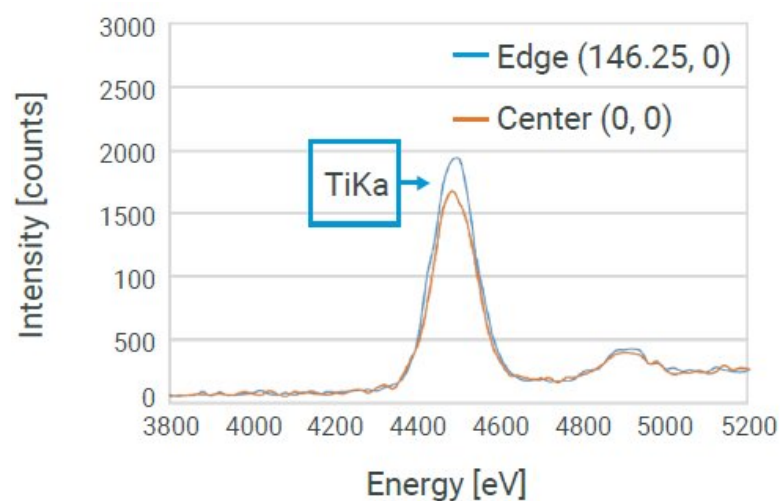
# Ultrathin film thickness

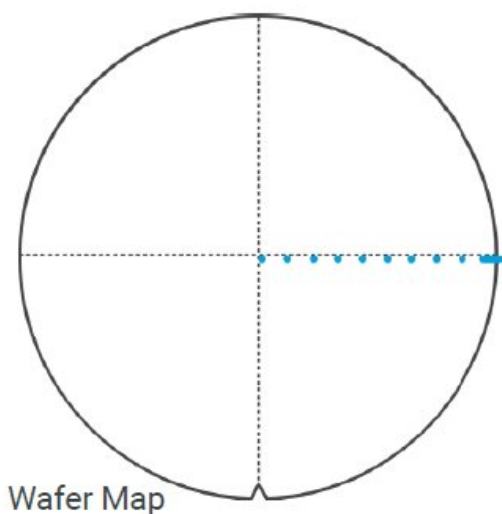
## FEOL wafer processing / blanket wafer

### Site comparison of 3 nm TiN layer – titanium nitride

- XRF spectra comparison of two sites of TiN, 3 nm nominal thickness.
- Ultrahigh sensitivity to thickness variation of down to 1 Å was demonstrated.
- The titanium peak was measured.

#### 2 Sites – titanium nitride film

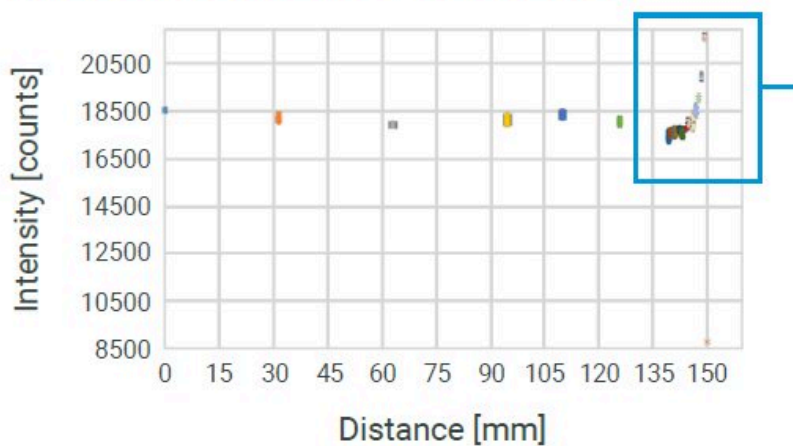




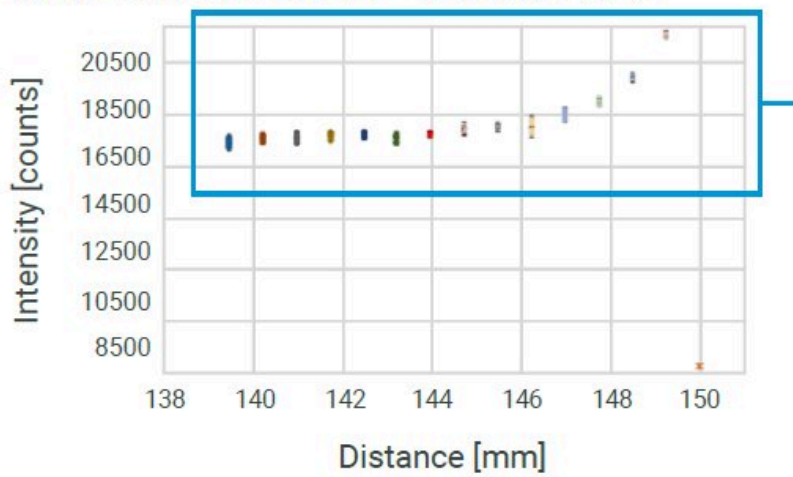
### Repeatability vs. Across-wafer variation – cobalt

- These graphs represent the process variation and tool precision of ultrathin film of cobalt.
- The layer thickness is 3 nm.
- The error bars represent  $1\sigma$  error, based on 10 repetitions.

## HALF WAFER SCAN – COBALT FILM



## WAFER EDGE SCAN – COBALT FILM



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## Related products



### ONYX 3000

EDXRF and optical hybrid metrology tool for automated X-ray analysis, 3D scanning, and 2D microscope for film thickness and composition measurements on blanket and patterned wafers for up to 300 mm wafers